



13281 U.S. PTO

012104

ATTORNEY DOCKET NO. 60188-747

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

17513 U.S. PTO
10/761098



012104

In re Reissue Application of:)

Customer No.: 20277

U.S. Patent No. 6,455,348)

Serial No.: 09/521,670)

Group Art Unit: 2825

Issued: September 24, 2002)

Examiner: G. LEE

Inventor: Yukio YAMAGUCHI)

For: LEAD FRAME, RESIN-MOLDED SEMICONDUCTOR DEVICE, AND METHOD
FOR MANUFACTURING THE SAME

TRANSMITTAL SHEET

Mail Stop **REISSUE**
Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Enclosed are the following documents:

1. Application Transmittal Form;
2. Reissue Application for the above-identified U.S. Patent;
3. Assent of Assignee to Reissue;
4. Request for Abstract of Title; and
5. Executed Declaration of the named inventor Pursuant to 37 CFR § 1.175(a).

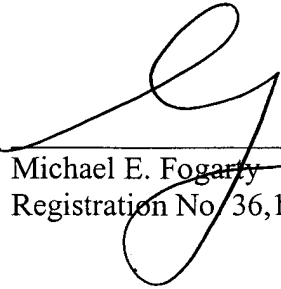
The Commissioner is hereby authorized to charge any fees associated with this

communication or credit any overpayment to Deposit Account No. 50-0417. A duplicate copy of this transmittal is enclosed for accounting purposes.

Respectfully submitted,

McDERMOTT, WILL & EMERY

Dated: 1/20/04

By: 
Michael E. Fogarty
Registration No. 36,139

600 13th Street, N.W., Suite 1200
Washington, D.C. 20005-3096
Telephone: (202) 756-8000
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WDC99 868991-1.060188.0747



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13281 U.S. PTO

Attorney Docket No.: 60188-747

Mail Stop **REISSUE**
Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450



20277

PATENT TRADEMARK OFFICE

REISSUE APPLICATION TRANSMITTAL

Dear Sir:

Transmitted herewith for filing is the X reissue utility
___ design patent application of Inventors:

(1) Yukio YAMAGUCHI.

Entitled:

LEAD FRAME, RESIN-MOLDED SEMICONDUCTOR DEVICE,
AND METHOD FOR MANUFACTURING THE SAME

1. Fee CalculationCLAIMS AS FILED

	<u>Number Filed</u>		<u>Number Extra</u>		<u>Rate</u>	Basic Fee \$770.00
Total Claims	15	- 20	0	X	\$ 18.00	0.00
Independent Claims	5	- 4	1	X	\$ 86.00	86.00
Multiple dependent claim(s), if any					\$290.00	0

Filing Fee Calculation \$856.00

___ Amendment cancelling extra claims enclosed

___ Amendment deleting multiple dependencies enclosed

2. Small Entity Statement

 A verified statement that this is a filing by a "small entity" under 37 CFR 1.9 and 1.27 is attached.
Filing Fee Calculation (50% of above) \$

3. Fee Payment

 Not Enclosed

 No filing fee is to be paid at this time.

 X Enclosed

 X Filing fee calculation above \$ 856.00

 Recording assignment
(\$40.00; 37 CFR 1.21(h)(1)) \$

Total fees enclosed \$ 856.00

4. Method of Payment of Fees

 Check in the amount of \$

 X Charge Deposit Account No. 50-0417 in
the amount of \$ 856.00

5. Other Enclosures:

6. Authorization to Credit Overpayment or Charge Additional Fees

 xx The Commissioner is hereby authorized to credit any overpayment, or charge fees under 37 CFR 1.16 (filing fees) or 37 CFR 1.17 (application processing fees) which may be required, to Deposit Account No. 50-0417. A duplicate copy of this Transmittal Letter is attached for accounting purposes.

7. Conditional Petition For Extensions of Time

xx Petition is hereby made under 37 CFR 1.136(a) for any extension of time required to ensure that any papers due in the U.S. Patent and Trademark Office during the pendency of this application are timely filed. Please charge any fees due for any extensions of time to Deposit Account No. 50-0417. A duplicate copy of this Transmittal Letter is attached for accounting purposes.

8. Correspondence Address:

McDERMOTT, WILL & EMERY
600 13th Street, N.W., Suite 1200
Washington, D.C. 20005-3096
Telephone: (202) 756-8000

Respectfully submitted,

McDERMOTT, WILL & EMERY

Dated: 1/20/04

By:



Michael E. Fogarty
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Washington, D.C. 20005-3096
Telephone: (202) 756-8000

Attachments
MEF/rp

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Application of:)	
)	Customer No.: 20277
U.S. Patent No. 6,455,348)	
)	Group Art Unit: 2825
Serial No.: 09/521,670)	
)	
Issued: September 24, 2002)	
)	Examiner: G. LEE
Inventor: Yukio YAMAGUCHI)	
)	
For: LEAD FRAME, RESIN-MOLDED SEMICONDUCTOR DEVICE, AND METHOD FOR MANUFACTURING THE SAME		

REISSUE APPLICATION

Mail Stop **REISSUE**
Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450
WDC99 860821-1.060188.0747

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Application of:)	
)	
U.S. Patent No. 6,455,348)	
)	Group Art Unit: 2825
Serial No.: 09/521,670)	
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Issued: September 24, 2002)	
)	Examiner: G. LEE
Inventor: Yukio YAMAGUCHI)	
)	
For: LEAD FRAME, RESIN-MOLDED SEMICONDUCTOR DEVICE, AND METHOD FOR MANUFACTURING THE SAME		

REQUEST FOR ABSTRACT OF TITLE

Mail Stop REISSUE
Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

It is respectfully requested that a certified Abstract of Title in respect to the above-identified U.S. Letters Patent No. 6,455,348 be placed in the official file of the Reissue Application which is being filed concurrently herewith.

The title to the Assignee, Matsushita Electric Industrial Co., Ltd., was recorded on July 24, 1996 at Reel 8081, Frame 0278.

Please charge Deposit Account No. 15-0417 for any fees which may be required for a search of assignment records, abstract of title and certification under 37 CFR § 1.19(b)(2). A

duplicate copy of this request is attached for accounting purposes.


Respectfully submitted,

McDERMOTT, WILL & EMERY

Dated:

1/21/04

By:



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